Backplane Round Robin 1 Test Plan - SCSI PIP T10/00-xxxr0 Umesh Chandra

T10/00-xxxr0 Backplane RR1 - - 1



Information the way you want it ...

The following LSI Logic documents are required for using this Test Plan:

- 1) U320 testboard_Agreement.PDF (License Agreement)
- 2) SCSI_Ultra_4_testboard.PDF (General Description)
- 3) U4_board_PWR.PDF (Test board block diagram)
- 4) U4_board_1.PDF (Circuit schematic page 1)
- 5) U4_board_2.PDF (Circuit schematic page 2)
- 6) U4_board_3.PDF (Circuit schematic page 3)
- 7) U4_board_4.PDF (Circuit schematic page 4)
- 8) U4_board_5.PDF (Circuit schematic page 5)



Test Board

Use SCSI_Ultra_4_testboard.PDF for detailed descriptions of the Test Board, all page numbers are with reference to this document. Read this document before starting this Test Plan.

1) Test board type used for this Test Plan has 'on-board' SCSI multi-mode terminators, which will be enabled for all tests - see page 1.

2) Below are the U8, U9 and U15 DIP switch settings (On is marked on the switch, see page 3 for switch functionality).

U8 2 10 3 5 7 8 9 11 12 1 4 6 off off off off off off on on on on on on **U9** 2 10 5 6 7 8 9 11 12 1 3 4 off off off off off off on off on off on on **U15** 2 7 8 9 10 3 5 11 12 1 4 6 off <-----> on T10/00-xxxr0 Backplane RR1 - - 3

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Test Equipment

The following test equipment was used by Seagate and is recommended for the Test Plan. However other equipment can be used, but results may be different. In order to standardize the "eye pattern" collection format, it is strongly recommended that a Tektronix 600 or 700 series digital scope be used, so that data can be readily captured, compared and interchanged between the Round Robin participants.

1) Digital Oscilloscope - TEK684B, 1 GHz, 5 GS/s, 4 channel

2) Differential Probe - TEK P6247, 1 GHz, input impedance 200Kohm in parallel with <1pF

3) Arbitrary Waveform Generator - TEK AWG2040, clock freq. 1 GHz, 8 bit DA converter, 1 M word waveform memory

4) SMA to BNC cables and 50 ohm terminators as required by the particular termination requirements of equipment used

5) LSI Logic G12 Ultra-4 SCSI Buffer Test Board with LSI TSTCHIP3 installed (supplied)

6) 2 X 5 slot Harbor Backplane with differential probe test points on DB10 and DB13 (supplied)

7) Twist and Flat cable (Supplied)

8) 5 plug in Seagate Drive PCBs (supplied)

9) 'Random.wfm' and 'Attenuation.wfm' data patterns on a floppy, required by the AWG2040 (supplied)

External terminators are not required for this test.



Test Configuration - LSIL Test Board to AWG

Please reference page 4 of the SCSI_Ultra_4_testboard.PDF document for configuring the Test Board.

1) The LSIL Test Board power connector is a standard 4 pin SCSI connector, only 5 Vdc and GND are required.

2) Connect 'J12' (160MHz clk OUT, LSIL Test Board) to 'Trig IN'(external trigger input of AWG). The random data generated by the AWG will then be synchronized with the the 160 MHz clock from the LSI Logic test chip.

3) DO NOT CONNECT 'J11' to 'Trig OUT'(trigger out of AWG). This connection is only used if the AWG is used to trigger the Test Chip. In our test plan, the Test Chip is used to trigger the AWG.

4) Connect 'J17'(LSIL Test Board) to 'Data OUT'(data pattern output of AWG). This injects random data into DB10 and DB13 of the LSI Logic Test Chip.

5) Connect 'J13'(LSIL Test Board) to 'Data OUT, inverted' (inverted data pattern output of AWG). This injects random data (inverted with respect to DB10 and DB13) into DB9, DB12 and DB15. This is used to simulate a worst case cross talk signal. 'J14' is internally connected to 'J13' on the Test Board. This injects the same cross talking signal, into DB8, DB11 and DB14. To summarize:

Data pattern IN (AWG) - DB10 and DB13 (LSIL Test Chip)

Cross Talk (inverted Data Pattern IN, AWG) - DB8, DB9, DB11, DB12, DB14 and DB15 (LSIL Test Chip)

T10/00-xxxr0 Backplane RR1 - - 5



Information the way you want it "

Test Configuration - LSIL Test Board to Digital Scope

Please reference page 4 of the SCSI_Ultra_4_testboard.PDF document for configuring the Test Board.

1) Connect J12, 160 MHz clk OUT (LSIL Test Board) to Channel 4 (Trigger input for Digital Scope).

2) Connect 'Launch test points, DB10 or DB13' (Jumper block LSIL Test Board, to the left of the 68 pin SCSI connector) to Channel 1 (Differential Probe Digital Scope). J85 is the (-) DB10 output, the (+) DB10 output is the adjacent jumper pin. J107 is the (-) DB13 output, the (+) DB13 output is the adjacent jumper pin)

T10/00-xxxr0 Backplane RR1 - - 6



Information the way you want it ...

Please reference page 4 of the SCSI_Ultra_4_testboard.PDF document for configuring the Test Board.

1) Connect 'Receive test points, DB10 or DB13 on the back of the 80 pin SEA connector of the Harbor Backplane, at each of the slot positions (1 through 10) to Channel 2 (Differential Probe Digital Scope).

2) Connect J9, 68 pin SCSI connector (LSIL Test Board) to J14 or J13, 68 pin SCSI connector (Harbor backplane) using the SCSI twist and flat cable provided.

3) Harbor Backplane

The backplane has two independent 5 slot backplanes, each has its own terminator. If the SCSI cable is connected to J14, then drive slots 1, 2, 3, 4 and 5 are active, the terminator is closest to drive slot 5. If the SCSI cable is connected to J13, then drive slots 6, 7, 8, 9 and 10 are active, the terminator is closest to drive slot 10.

Each of the 5 slot backplanes have a separate 4 pin standard SCSI power connector.



Load the 'Attenuation.wfm' waveform into the AWG2040 or equivalent. The 'Attenuation.wfm' waveform has a low frequency of 1 MHz (to simulate DC), followed by a burst of 80MHz.

Measure the peak to peak differential amplitude of the 1 MHz at the 'launch test points' for DB10 and DB13, refer to page 6 for connection information. This measurement gives the low frequency or DC amplitude at the driver output of the LSIL Test Chip. This measurement is made using the horizontal cursors on the TEK scope. The cursors can be selected by pressing the 'Cursor' button and then the 'Horizontal' button. The 'launch test point' amplitude measurement is made only once.

Measure the peak to peak differential amplitude of the 80 MHz at the 'receive test points' for DB10 and DB13, refer to page 7 for connection information. This measurement gives the high frequency amplitude at the backplane slot (receiver end). Repeat this measurement for slot positions 1 -5 and 6 -10. Use horizontal cursors to make this measurement.

Attenuation = 20 log (peak-peak amplitude at receive test point / peak-peak amplitude at launch)

T10/00-xxxr0 Backplane RR1 - - 8



Information the way you want it "

Trigger Method for Eye Pattern Generation

1) Channel 4 - Trigger from J12 on LSIL Test board, 160MHz clk Out
Trigger - Normal
Type - Edge
Source - CH4
Coupling - DC
Slope - +
Adjust trigger level to get a stable trigger on the clock signal.

2) <u>Channel 1 or 2</u>	3) Display Settings - Infinite Persistence
Vertical - Channel 1 or 2	Horizontal - 1 nsec/div
Coupling - Dc	Data Points - 500
Bandwidth - full	4) <u>Saving Data</u>
Fine Scale - 200mv/div	Use the floppy drive in the Tek scope to save eye diagrams.
Position - 0 div	Press the 'Run' button to start acquisitions.
Offset - 0 v	After 30 sec., press the 'Run' button again to Stop acquisitions.
Deskew - 0 s	Save in PCX format by pressing the 'Waveform' button

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T10/00-xxxr0 Backplane RR1 - - 9

Information the way you want it ...

1) Attenuation - Use the method described on page 8 to make attenuation measurements. The input signal amplitude is measured at the launch test point (DB10 and DB13, Channel 1). The output amplitude is measured at the receive test point (DB10 and DB13, Channel 2).

The attenuation is calculated for every slot position: 1 - 5, and 6 -10.

2) Eye Diagram - Use the method described on page 9 to capture "eye diagrams" at every slot position: 1 -5 and 6 -10.

All the above measurements were made with minimum slew rate, minimum primary driver strength and minimum secondary driver strength, with precomp enabled. Per the setting made on page three.

Change the slew rate settings, by adjusting U8 switches 2, 3, and 4, to visually open the eye diagram, if possible, repeat measurements 1 & 2 for the new slew rate setting.

This is the basic set of recommended measurements. The user can change slew rate, drive strengths and precomp levels to make other measurements. Also this basic setup can be used to make cable measurements. Instead of using a backplane, use a long cable (round shielded or twist & flat) and a feed through terminator at the far end and a drive PCB load, and make cable attenuation and eye diagram measurements.

